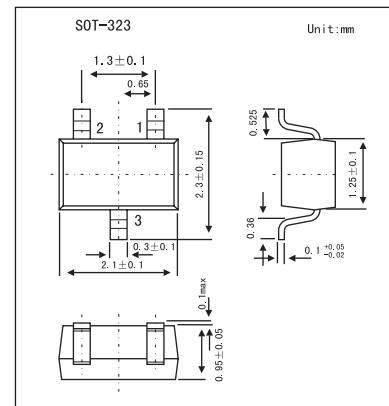
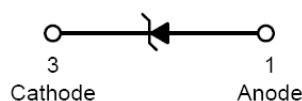


## 200mW Surface Mount Zener Diode

### MMBZ5241BW

#### ■ Features

- Planar Die Construction
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes



#### ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Forward Voltage @ If = 10mA	VF	0.9	V
Power Dissipation *1	Pd	200	mW
Thermal Resistance, Junction to Ambient Air *1	R <sub>θJA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150	°C

\*1. Part mounted on FR-4 PC board with recommended pad layout

#### ■ Electrical Characteristics @TA=25°C unless otherwise specified

Type Number	Zener Voltage Range *1			Maximum Zener Impedance *2		Maximum Reverse Leakage Current *1	
	Vz @ IzT		IzT	ZzT @ IzT	Zzk @ Izk= 0.25mA	IR	@ VR
	Nom (V)	Min (V)	Max (V)	mA	Ω	uA	V
MMBZ5241BW	11	10.45	11.55	20	22	600	2

\*1. Short duration test pulse used to minimize self-heating effect.

\*2. f = 1KHz.

#### ■ Marking

Marking	KH1
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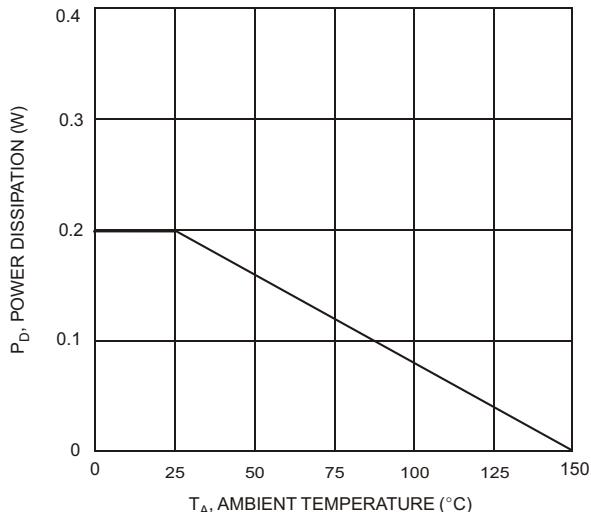
**MMBZ5241BW**

Fig. 1 Power Dissipation vs Ambient Temperature

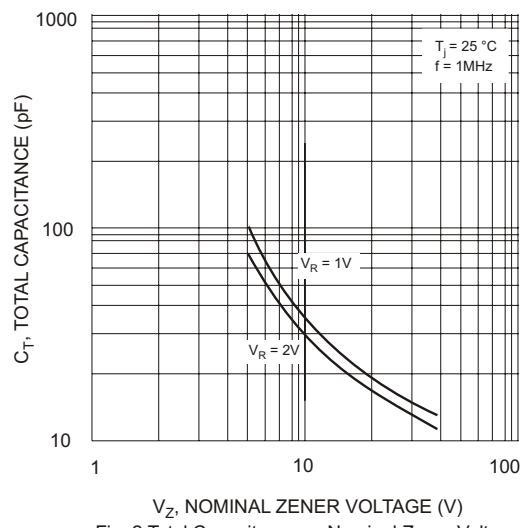


Fig. 2 Total Capacitance vs Nominal Zener Voltage

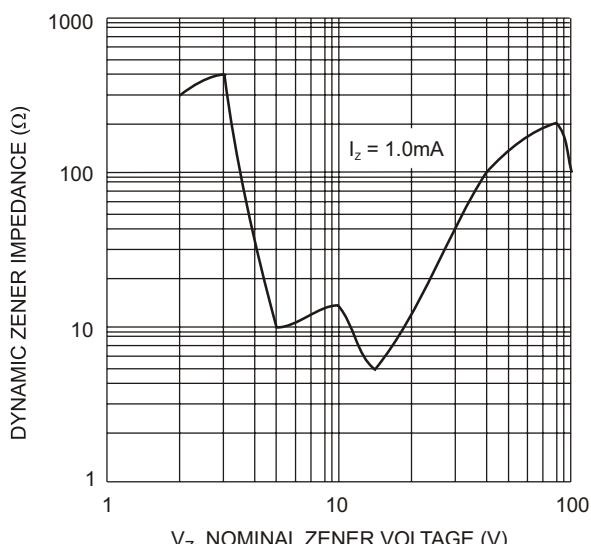


Fig. 3 Zener Voltage vs. Zener Impedance

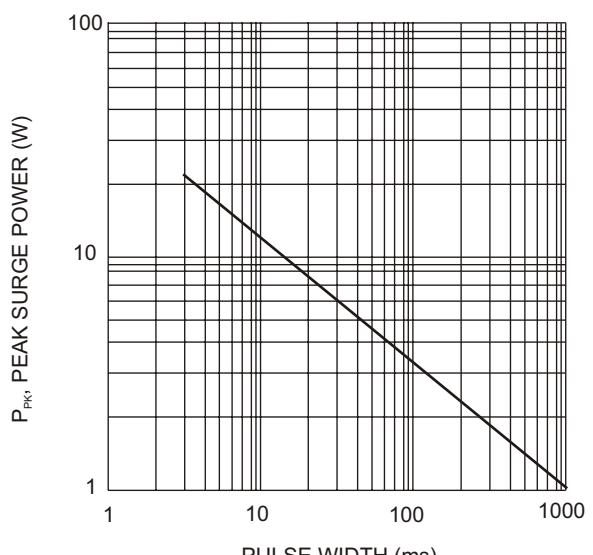


Fig. 4 Maximum Non-repetitive Surge Power

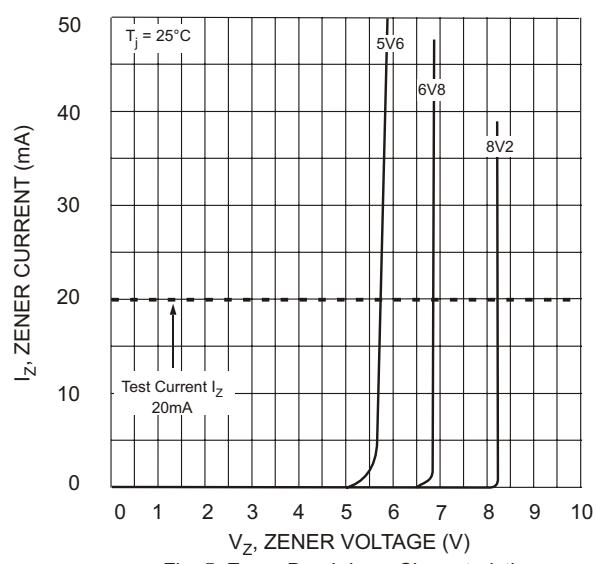
**MMBZ5241BW**

Fig. 5 Zener Breakdown Characteristics

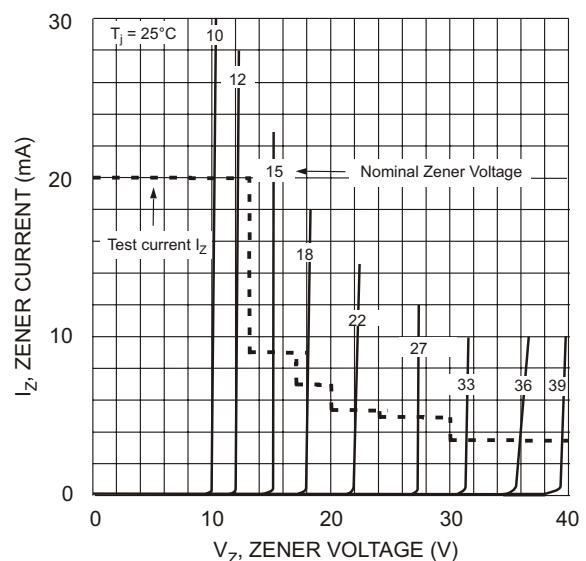


Fig. 6 Zener Breakdown Characteristics